

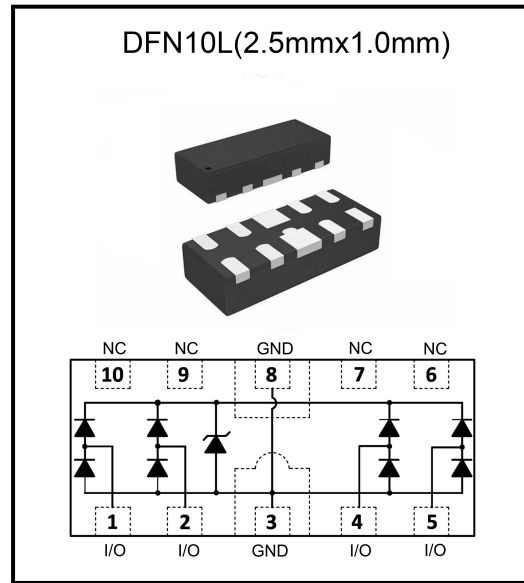
# BNCS0806S

## ESD Protection Diode Array

### Features

- 52Watts peak pulse power (tp = 8/20µs)
- Unidirectional configurations
- Solid-state silicon-avalanche technology
- Low clamping Voltage
- Low leakage current
- Low capacitance (Cj=0.3pF typ.I/O to I/O)
- Protection one data/power line
- IEC 61000-4-2 ±20kV contact ; ±20kV air
- IEC 61000-4-4 (EFT) 40A (5/50ns)
- IEC 61000-4-5 (Lightning) 3.5A (8/20µs)

### Package



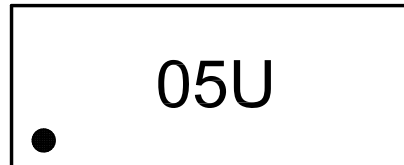
### Applications

- USB3.0, USB2.0,Ethernet
- HDMI 1.4, Displayport 1.3,eSATA
- Unified Display interface
- Digital Visual Interface
- High speed serial interface

### Mechanical Data

- Tiny DFN10L(2.5mmx1.0mm) package
- Molding compound flammability rating: UL 94V-0
- Packaging: Tape and Reel
- RoHS/WEEE Compliant

### Marking



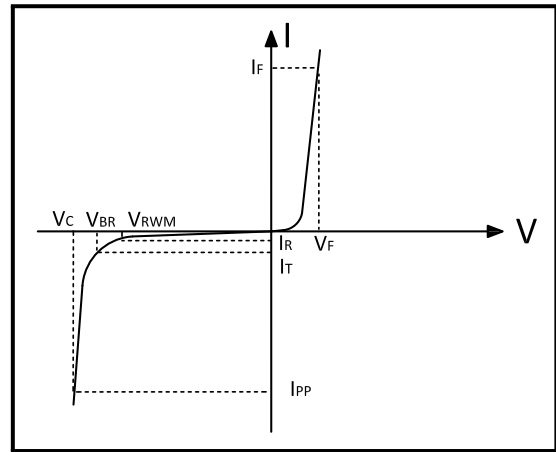
### Ordering information

Order code	Package	Base qty	Delivery mode
BNCS0806S	DFN10L(2.5mmx1.0mm)	3k	Tape and reel



### Electrical Parameters (T<sub>A</sub> = 25°C unless otherwise noted)

Symbol	Parameter
I <sub>PP</sub>	Maximum Reverse Peak Pulse Current
V <sub>C</sub>	Clamping Voltage @ I <sub>PP</sub>
V <sub>RWM</sub>	Peak Reverse Working Voltage
I <sub>R</sub>	Reverse Leakage Current @ V <sub>RWM</sub>
V <sub>BR</sub>	Breakdown Voltage @ I <sub>T</sub>
I <sub>T</sub>	Test Current



Note: 8/20us pulse Waveform.

### Absolute Maximum Rating

Rating	Symler	Value	Units
Peak Pulse Power (tp = 8/20μs)	P <sub>PP</sub>	52	Watts
Peak Pulse Current (tp = 8/20μs)	I <sub>PP</sub>	3.5	A
ESD per IEC 61000-4-2 (Air)	V <sub>ESD</sub>	20	KV
ESD per IEC 61000-4-2 (Contact)		20	
Lead Soldering Temperature	T <sub>L</sub>	260(10seconds)	°C
Junction Temperature	T <sub>J</sub>	-55 to + 150	°C
Storage Temperature	T <sub>stg</sub>	-55 to + 150	°C

### Electrical Characteristics

Parameter	Symler	Conditions	Min	Typical	Max	Units
Reverse Stand-Off Voltage	V <sub>RWM</sub>	–	–	–	5.0	V
Reverse Breakdown Voltage	V <sub>BR</sub>	I <sub>T</sub> =1mA	6.0	7.5	9.5	V
Reverse Leakage Current	I <sub>R</sub>	V <sub>RWM</sub> =5V, T=25°C	–	–	0.5	uA
Peak Pulse Current	I <sub>PP</sub>	tp = 8/20us	–	–	3.5	A
Clamping Voltage	V <sub>C</sub>	I <sub>PP</sub> =3.5A, tp = 8/20us	–	12	15	V
Junction Capacitance	C <sub>j</sub>	V <sub>R</sub> =0V, f=1MHZ, I/O to I/O	–	0.20	0.35	pF
		V <sub>R</sub> =0V, f=1MHZ, I/O to GND	–	0.30	0.5	



Typical Characteristics

Figure 1: Peak Pulse Power vs. Pulse Time

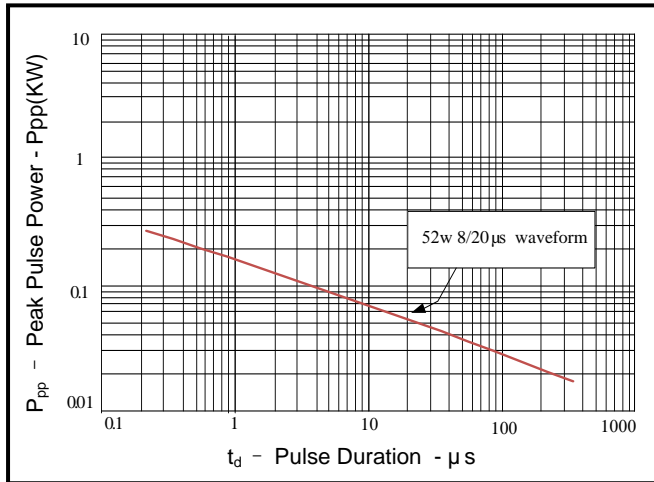


Figure 2: Power Derating Curve

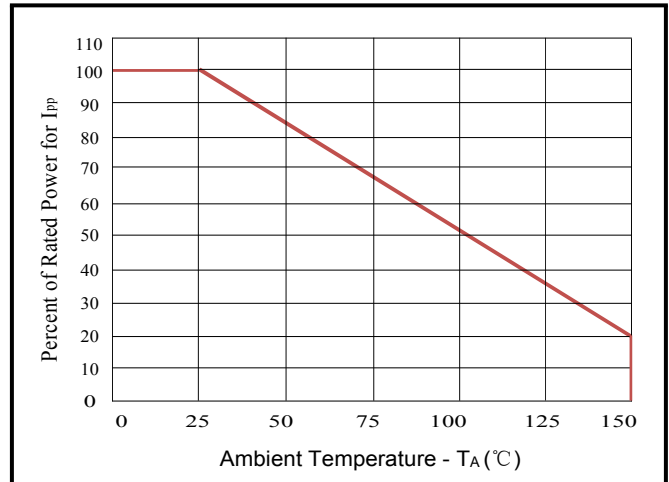


Figure 3: Pulse Waveform

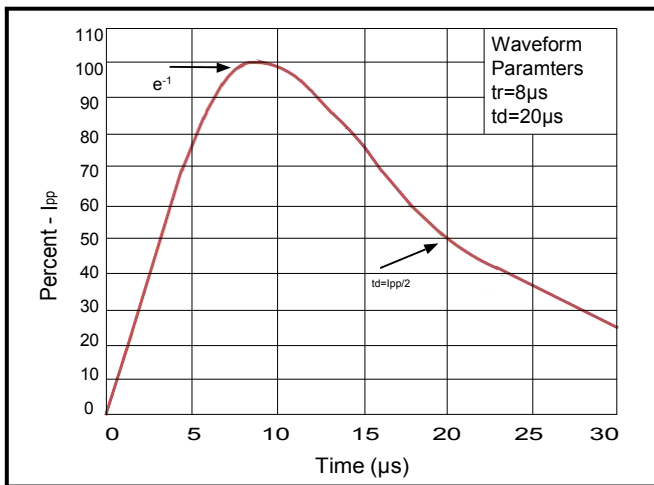
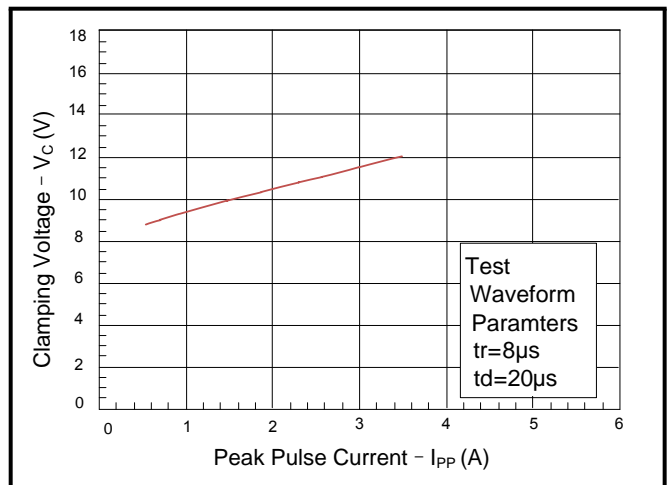


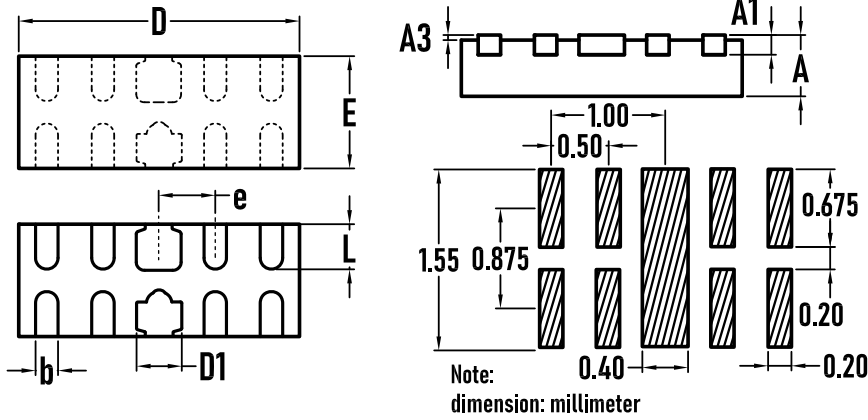
Figure 4: Clamping Voltage vs. Ipp



**BNCS0806S**

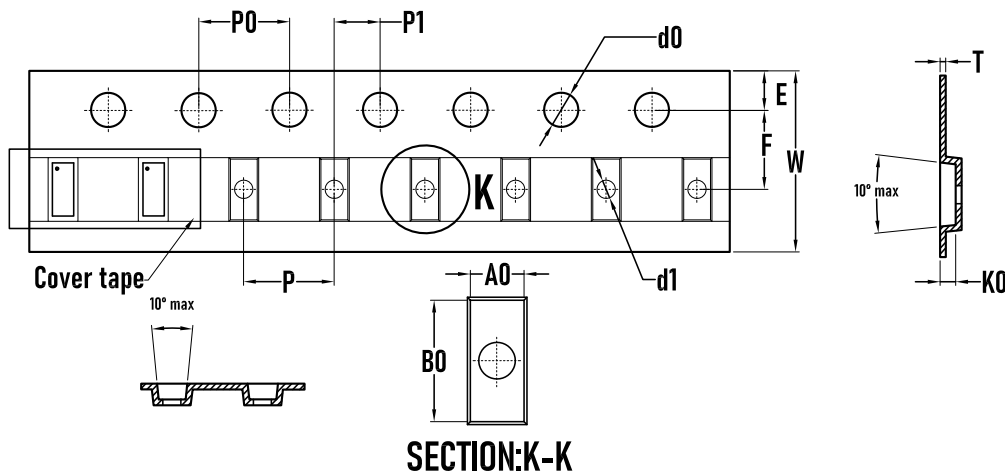
**ESD Protection Diode Array**

**Outline Drawing – DFN10L(2.5mmx1.0mm)**



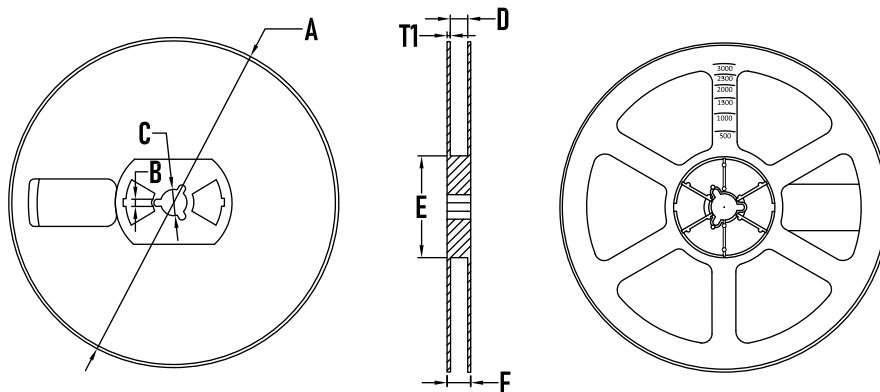
SYMBOL	MILLIMETER		
	MIN.	Typ.	MAX.
A	0.45	0.50	0.55
A1	–	0.02	0.05
A3	0.10	0.15	0.20
D	2.45	2.50	2.55
E	0.95	1.00	1.05
D1	0.35	0.40	0.45
b	0.15	0.20	0.25
e	0.50BSC		
L	0.35	0.40	0.45

**Packaging Tape - DFN2510-10L**



SYMBOL	MILLIMETER
A0	1.2±0.05
B0	2.7±0.05
d0	1.5 <sup>+0.1</sup> <sub>-0</sub>
d1	0.8±0.1
E	1.75±0.10
F	3.50±0.05
K0	0.7±0.05
P	4.00±0.05
P0	4.00±0.05
P1	8.00±0.05
W	8.00 <sup>+0.03</sup> <sub>-0.01</sub>
T	0.22±0.03

**Packaging Reel**



SYMBOL	MILLIMETER
A	178±1
B	3.5±0.2
C	14.3±0.2
D	9.8 <sup>+2</sup> <sub>-1</sub>
E	54.5±0.5
F	12.4±0.5
T1	1.0±0.2
Quantity	3000PCS

